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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10039219	01/02/2002	257	678 ⁺	2814	D. NGUYEN
**APPLICANTS: Ke Chun-Chi; Lo Randy; Wu ChiChuan;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED: TAIWAN 90110468 05/02/2001					
PG-PUB		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed		<input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO	
35 USC 119 conditions met		<input type="checkbox"/> yes <input type="checkbox"/> no		56843 (71987)	
Verified and Acknowledged Examiners's initials					
TITLE : Semiconductor package and method for fabricating the same					

U.S. DEPT. OF COM. / PAT. & TM. PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	
ISSUE FEE		Total Claims	
Amount Due	Date Paid	Print Claim for O.G.	
		DRAWING	
		Sheets Drwg.	Figs. Drwg.
		Print Fig.	
		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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